

Specification for Approval

Date: 2017/10/17

Customer: 深圳 臺慶

TAI-TECH P/N:

HDMI2012F2SF-SERIES

	CUSTOMER P/N:						
	DESCRIPTION:						
	QUANTITY:	pcs	<u>3 </u>				
REM	IARK:						
	Cı	ıstomer Approval Feedba	ack				
				_			

■ 西北臺慶科技股份有限公司

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楊祥忠	林志鴻	張展耀
Mike Yang	Zhi-Hong Lin	Kevin Chang

Wire Wound Type Common Mode Filter

HDMI2012F2SF-SERIES

	ECN HISTORY LIST						
REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN		
1.0	17/10/17	新 發 行	楊祥忠	林志鴻	張展耀		
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Wire Wound Type Common Mode Filter

HDMI2012F2SF-SERIES

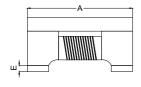
1.Features

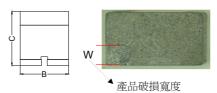
- 1. High common mode impedance at high frequency effects excellent noise suppression performance.
- 2. HDMI2012F2SF series realizes small size and low profile. 2.0x1.2x1.2 mm.
- 3. 100% Lead(Pb) & Halogen-Free and RoHS compliant.



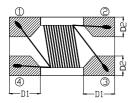


2.Dimension





當破損面積<5%,產品列入允收品範圍



Series	A(mm)	B(mm)	C(mm)	D1(mm)	D2(mm)	E(mm)
2012F2SF	2.0±0.2	1.2±0.2	1.2±0.2	0.50±0.1	0.51±0.1	0.15±0.1

3.Part Numbering



A: Series

B: Dimension

C: Material Ferrite
D: Number of Lines 2=2 lines

E: Type S=One Circuit Type , N=Unshielded

F: Lead free

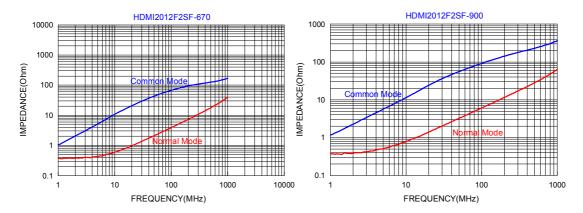
G: Impedance $670=67 \Omega$

H: Packaging T=Taping and Reel, B=Bulk

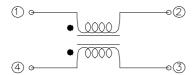
I: Rated Current 04=400mA

4.Specification

TAI-TECH Part Number		n mode ance (Ω)	Test Frequency (MHz)	DC Resistance (Ω) max.	Rated Current (mA)	Rated Volt. (Vdc)	Withstand Volt. (Vdc)	IR (Ω) min.
HDMI2012F2SF-670T04	67 typ.	50 min.	100	0.30	400	50	125	10M
HDMI2012F2SF-900T04	90 typ.	65 min.	100	0.30	400	50	125	10M

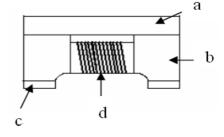


5.Schematic Diagram



6. Materials

No.	Description	Specification
a.	Upper Plate	Ferrite
b.	Core	Ferrite Core
С	Termination	Tin Pb Free
d	Wire	Enameled Copper Wire



7. Reliability and Test Condition

Item	Performance	Test Condition				
Operating temperature	-40~+125℃ (Including self - temperature rise)					
Storage temperature	-40~+125℃ (on board)					
Electrical Performance Tes	Electrical Performance Test					
Z(common mode)		Agilent-4291A+ Agilent -16197A				
DCR	Refer to standard electrical characteristics list.	Agilent-4338B				
I.R.		Agilent4339				
		Applied the allowed DC current. Temperature measured by digital surface thermometer				

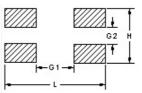
Reliability Test		
		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles)
		Temperature : 125±2°ℂ
Life Test		Applied current : rated current
		Duration: 1000±12hrs
		Measured at room temperature after placing for 24±2 hrs
		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles
Load Humidity		Humidity: 85±2%R.H,
		Temperature : 85°C±2°C
		Duration: 1000hrs Min. with 100% rated current
	_	Measured at room temperature after placing for 24±2 hrs
Moisture Resistance	Appearance: No damage. Inductance: within±10% of initial value Impedance: within±15% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles 1. Baked at50℃ for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65±2℃ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25℃ in 2.5hrs. 3. Raise temperature to 65±2℃ 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25℃ in 2.5hrs, keep at 25℃ for 2 hrs then keep at -10℃ for 3 hrs 4. Keep at 25℃ 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.
Thermal shock		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1: -40±2°C 30±5min
		Step2 : 25±2°C ≤0.5min
		Step3 : 125±2℃ 30±5min
		Number of cycles: 500
	-	Measured at room temperature after placing for 24±2 hrs Oscillation Frequency: 10 ~ 2K ~ 10Hz for 20 minutes
Vibration		Equipment: Vibration checker
		Total Amplitude:1.52mm±10% Testing Time : 12 hours(20 minutes, 12 cycles each of 3
		orientations)₀

Item	Performance	Test Condition			
Bending	Appearance : No damage. Impedance : within±15% of initial value	Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.			
Shock	Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	Type Peak value (g's) Normal duration (D) (ms) Wave form Velocity change (Vi)ft/sec SMD 50 11 Half-sine 11.3 Lead 50 11 Half-sine 11.3			
Solder ability	More than 95% of the terminal electrode should be covered with solder。	Preheat: 150°C,60sec.。 Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5°C ∘ Flux for lead free: Rosin. 9.5% ∘ Dip time: 4±1sec ∘ Depth: completely cover the termination			
Resistance to Soldering Heat		Depth: completely cover the termination Temperature ramp/immersion and emersion rate 260 ±5 (solder temp) Number of heat cycles			
Terminal	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a force(>0805:1kg, <=0805:0.5kg)to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.			
Strength		DUT wide thick			

8. Soldering and Mounting

8-1. Recommended PC Board Pattern

	HDMI2012F2S			
L	2.60			
Н	1.40			
G1	1.25			
G2	0.45			



PC board should be designed so that products can prevent damage from mechanical stress when warping the board.

Products shall be positioned in the sideway direction against the mechanical stress to prevent failure.

8-2. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

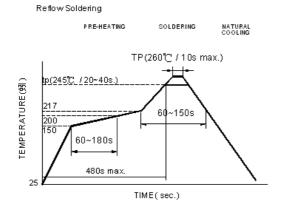
8-2.1 Lead Free Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

8-2.2 Soldering Iron(Figure 2):

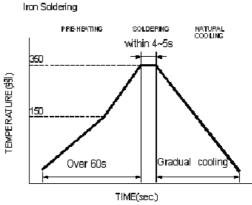
Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- Preheat circuit and products to 150°C Never contact the ceramic with the iron tip Use a 20 watt soldering iron with tip diameter of 1.0mm
- 355°C tip temperature (max) 1.0mm tip diameter (max) Limit soldering time to 4~5 sec.



Reflow times: 3 times max.

Fig.1

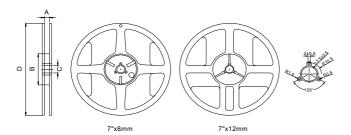


Iron Soldering times: 1 times max.

Fig.2

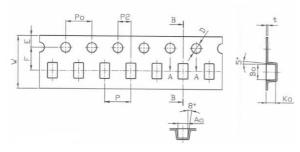
9. Packaging Information

9-1. Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	9.0±0.5	60±2	13.5±0.5	178±2

9-2. Tape Dimension / 8mm

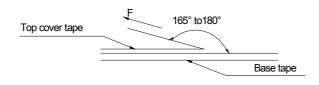


Series	W(mm)	P(mm)	E(mm)	F(mm)	P2(mm)	D(mm)	P0(mm)	A0(mm)	B0(mm)	K0(mm)	t(mm)
HDMI2012F2S	8.00±0.10	4.00±0.10	1.75±0.10	3.50±0.05	2.00±0.05	1.50+0.10/-0.00	4.00±0.10	1.50±0.10	2.35±0.10	1.45±0.10	0.28±0.05

9-3. Packaging Quantity

Chip size	Chip/Reel	Inner Box	Middle Box	Carton
HDMI2012F2S	2000	10000	50000	100000

9-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed	
(℃)	(%)	(hPa)	mm/min	
5~35	45~85	860~1060	300	

Application Notice

Storage Conditions(component level)

To maintain the solderability of terminal electrodes:

- 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 3. Recommended products should be used within 12 months form the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.





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日期(Date): 2017/10/06

頁數(Page): 1 of 16

Test Report

西北臺慶科技股份有限公司 / TAI-TECH ADVANCED ELECTRONICS CO., LTD.

(臺慶精密電子(昆山)有限公司 / TAI-TECH ADVANCED EECTRONICS (KUN-SHAN) CO. LTD.)

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(中國,江蘇省,宿遷市,泗洪縣,經濟開發區杭州路南側,建設北路東側 / THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD, ECONOMIC DEVELOPMENT ZONE, SIHONG COUNTY, SUQIANCITY, JIANGSU PROVINCE, P, R, CHINA)

以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by/on behalf of the applicant as):

樣品名稱(Sample Description)

WIREWOUND SERIES

樣品型號(Stvle/Item No.)

WCM、WCL、HSF、HDMI、DVI、BCM、PCM、TCM、LCM、LPF、TXF、ACM、DCM、WIH、

BPH . TNH SERIES

收件日期(Sample Receiving Date)

2017/09/29

測試期間(Testing Period)

2017/09/29 TO 2017/10/06

測試結果(Test Results) :

請參閱下一頁 (Please refer to following pages).



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測試結果(Test Results)

測試部位(PART NAME)No.1

: 整體混測(MIXED ALL PARTS)

測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限值 (MDL)	結果 (Result) No.1
鍋 / Cadmium (Cd)	mg/kg	參考IEC 62321-5 (2013),以感應耦合 電漿原子發射光譜儀檢測. / With reference to IEC 62321-5 (2013) and performed by ICP-AES.	2	n. d.
鉛 / Lead (Pb)	mg/kg	参考IEC 62321-5 (2013),以感應耦合電漿原子發射光譜儀檢測. / With reference to IEC 62321-5 (2013) and performed by ICP-AES.	2	n. d.
汞 / Mercury (Hg)	mg/kg	參考IEC 62321-4 (2013),以感應耦合 電漿原子發射光譜儀檢測. / With reference to IEC 62321-4 (2013) and performed by ICP-AES.	2	п. d.
六價鉻 / Hexavalent Chromium Cr(VI) (◆)	mg/kg	参考IEC 62321-7-2 (2017),以UV-VIS 檢測;参考IEC 62321-5 (2013),以 ICP-AES檢測. / With reference to IEC 62321-7-2 (2017) and performed by UV-VIS.; With reference to IEC 62321-5 (2013) and performed by ICP-AES.	8	n. d.
銻 / Antimony (Sb)	mg/kg	参考US EPA 3050B (1996),以感應耦合電漿原子發射光譜儀檢測. / With reference to US EPA 3050B (1996). Analysis was performed by ICP-AES.	2	n. d.

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測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1
鈹 / Beryllium (Be)	mg/kg	参考US EPA 3050B (1996),以感應耦合電漿原子發射光譜儀檢測. / With reference to US EPA 3050B (1996). Analysis was performed by ICP-AES.	2	n. d.
全氟辛烷磺酸 / Perfluorooctane sulfonates (PFOS-Acid, Metal Salt, Amide)	mg/kg	参考US EPA 3550C (2007), 以液相層析/質譜儀檢測. / With reference to US EPA 3550C (2007). Analysis was performed by LC/MS.	10	n, d,
全氟辛酸 / PFOA (CAS No.: 335-67-1)	mg/kg	參考US EPA 3550C (2007), 以液相層析/質譜儀檢測. / With reference to US EPA 3550C (2007). Analysis was performed by LC/MS.	10	n. d.
聚氯乙烯 / PVC	**	以紅外光譜分析及焰色法檢測. / Analysis was performed by FTIR and FLAME Test.	_	Negative
六溴環十二烷及所有主要被辨別出的異構物 / Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified (α - HBCDD, β - HBCDD, γ - HBCDD) (CAS No.: 25637-99-4 and 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8))	mg/kg	参考IEC 62321 (2008),以氣相層析/ 質譜儀檢測. / With reference to IEC 62321 (2008). Analysis was performed by GC/MS.	5	n. d.

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測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1
鄰苯二甲酸丁苯甲酯 / BBP (Butyl Benzyl phthalate) (CAS No.: 85-68-7)	mg/kg		50	n. d.
鄰苯二甲酸二丁酯 / DBP (Dibutyl phthalate) (CAS No.: 84-74-2)	mg/kg		50	n. d.
鄭苯二甲酸二 (2-乙基己基)酯 / DEHP (Di- (2-ethylhexyl) phthalate) (CAS No.: 117-81-7)	mg/kg		50	n. đ.
鄰苯二甲酸二異丁酯 / DIBP (Di- isobutyl phthalate) (CAS No.: 84-69- 5)	mg/kg	参考IEC 62321-8 (2017),以氣相層析	50	n. d.
鄭苯二甲酸二異癸酯 / DIDP (Di- isodecyl phthalate) (CAS No.: 26761- 40-0; 68515-49-1)	mg/kg	儀/質譜儀檢測. / With reference to IEC 62321-8 (2017). Analysis was performed by GC/MS.	50	n. d.
鄉苯二甲酸二異壬酯 / DINP (Di- isononyl phthalate) (CAS No.: 28553- 12-0; 68515-48-0)	mg/kg		50	n. d.
鄰苯二甲酸二正辛酯 / DNOP (Di-n-octyl phthalate) (CAS No.: 117-84-0)	mg/kg		50	n. d.
鄰苯二甲酸二正己酯 / DNHP (Di-n- hexyl phthalate) (CAS No.: 84-75-3)	mg/kg		50	n. d.
鄰苯二甲酸二戊酯 / Di-n-pentyl phthalate (CAS No.: 131-18-0)	mg/kg		50	n. d.

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測試項目 (Test Items)	單位 (Unit)	测試方法 (Method)	方法偵測極限値	結果 (Result)
	(5.1.1.0)	(No shot)	(MDL)	No. 1
多溴聯苯總和 / Sum of PBBs	mg/kg		_	n. d.
一溴聯苯 / Monobromobiphenyl	mg/kg		5	n. d.
二溴聯苯 / Dibromobiphenyl	ng/kg		5	n. d.
三溴聯苯 / Tribromobiphenyl	mg/kg		5	n. d.
四溴聯苯 / Tetrabromobiphenyl	mg/kg	[5	n, d.
五溴聯苯 / Pentabromobiphenyl	mg/kg		5	n. d.
六溴聯苯 / Hexabromobiphenyl	mg/kg		5	n. d.
七溴聯苯 / Heptabromobiphenyl	mg/kg		5	n. d.
八溴聯苯 / Octabromobiphenyl	mg/kg		5	n. d.
九溴聯苯 / Nonabromobiphenyl	mg/kg] 参考IEC 62321-6 (2015),以氣相層析 [5	n. d.
十溴聯苯 / Decabromobiphenyl	mg/kg	/質譜儀檢測. / With reference to	5	n. d.
多溴聯苯醚總和 / Sum of PBDEs	mg/kg	IEC 62321-6 (2015) and performed	_	n, d,
一溴聯苯醚 / Monobromodiphenyl ether	mg/kg	by GC/MS.	5	n, d.
二溴聯苯醚 / Dibromodiphenyl ether	mg/kg		5	n, d.
三溴聯苯醚 / Tribromodiphenyl ether	mg/kg	[5	n, d,
四溴聯苯醚 / Tetrabromodiphenyl ether	mg/kg		5	n. d.
五溴聯苯醚 / Pentabromodiphenyl ether	mg/kg		5	n. d.
六溴聯苯醚 / Hexabromodiphenyl ether	mg/kg	[5	n. d.
七溴聯苯醚 / Heptabromodiphenyl ether	mg/kg	Γ	5	n. d.
八溴聯苯醚 / Octabromodiphenyl ether	mg/kg	Ι Γ	5	n. d.
九溴聯苯醚 / Nonabromodiphenyl ether	mg/kg		5	n. d.
十溴聯苯醚 / Decabromodiphenyl ether	mg/kg		5	n. d.

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測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1
鹵素 / Halogen				
鹵素(氟)/ Halogen-Fluorine (F) (CAS No.: 14762-94-8)	mg/kg		50	n. d.
鹵素(氣)/ Halogen-Chlorine (C1) (CAS No.: 22537-15-1)	mg/kg	参考BS EN 14582 (2016),以離子層析 儀分析. / With reference to BS EN	50	n. d.
鹵素(溴)/ Halogen-Bromine (Br) (CAS No.: 10097-32-2)	mg/kg	14582 (2016). Analysis was performed by IC.	50	n. d.
鹵素(碘)/ Halogen-Iodine(I)(CAS No.: 14362-44-8)	mg/kg		50	n. d.

備註(Note):

- 1. mg/kg = ppm ; 0.1wt% = 1000ppm
- 2. n.d. = Not Detected (未檢出)
- 3. MDL = Method Detection Limit (方法偵測極限值)
- 4. "-" = Not Regulated (無規格值)
- 5. **= Qualitative analysis (No Unit) 定性分析(無單位)
- 6. Negative = Undetectable 陰性(未偵測到); Positive = Detectable 陽性(已偵測到)
- 7. (lacktriangleright) :

若鉻含量小於六價鉻之方法偵測極限值,則六價鉻為n.d.,不須再測試六價鉻。

The result of Cr(VI) is "n.d." as the result of Chromium (Cr) is less than the MDL of Cr(VI), and confirmation test of Cr(VI) is not required.

若鉻含量未小於六價鉻之方法偵測極限值,需進行六價鉻測試。

If the Chromium (Cr) content is not less than the MDL of Cr(VI), confirmation test of Cr(VI) is required.

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8. 横品的測試是基於申請人要求混合測試,報告中的混合測試結果不代表其中個別單一材質的含量. (The samples was/were analyzed on behalf of the applicant as mixing sample in one testing. The above results was/were only given as the informality value.)

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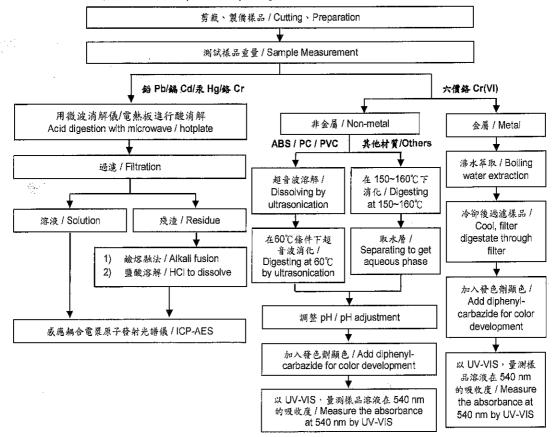
重金屬流程圖 / Analytical flow chart of Heavy Metal

根據以下的流程圖之條件,樣品已完全溶解。(六價絡測試方法除外)

These samples were dissolved totally by pre-conditioning method according to below flow chart. (Cre+ test method excluded)

测試人員:王志瑋 / Technician : JR Wang

測試負責人:張啟興 / Supervisor: Troy Chang



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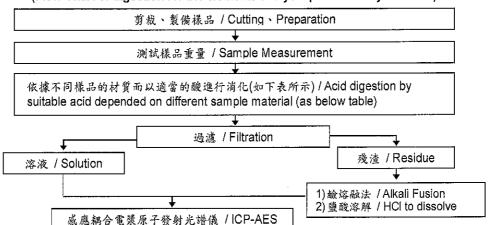
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> 根據以下的流程圖之條件,樣品已完全溶解。 / These samples were dissolved totally by pre-conditioning method according to below flow chart.

- 測試人員:王志瑋 / Technician: JR Wang
- 測試負責人:張啟興 / Supervisor: Troy Chang

元素以 ICP-AES 分析的消化流程圖 (Flow Chart of digestion for the elements analysis performed by ICP-AES)



鋼,銅,銘,焊錫 / Steel, copper, aluminum, solder	王水,硝酸,鹽酸,氫氣酸,雙氧水/
	Aqua regia, HNO ₃ , HCl, HF, H ₂ O ₂
玻璃 / Glass	硝酸,氫氯酸 / HNO3/HF
金,鉑,鈀,陶瓷 / Gold, platinum, palladium, ceramic	王水 / Aqua regia
銀 / Silver	硝酸 / HNO ₃
塑膠 / Plastic	硫酸,雙氧水,硝酸,鹽酸 / H ₂ SO ₄ , H ₂ O ₂ , HNO ₃ , HCI
其他 / Others	加入適當的試劑至完全溶解 / Added appropriate reagent to total digestion

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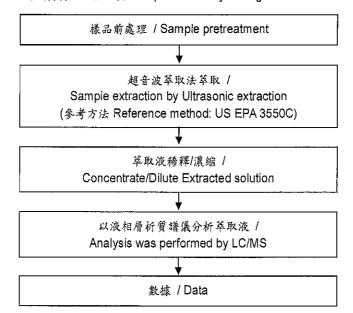
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全氟辛酸/全氟辛烷磺酸分析流程圖 / Analytical flow chart - PFOA/PFOS

測試人員:涂雅苓 / Technician: Yaling Tu

測試負責人:張啟興 / Supervisor: Troy Chang



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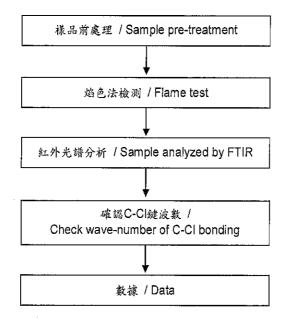
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聚氯乙烯物質判定分析流程圖 / Analysis flow chart - PVC

- 測試人員:涂雅苓 / Technician: Yaling Tu
- 測試負責人:張啟興 / Supervisor: Troy Chang



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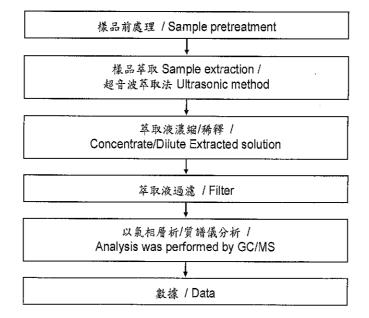
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六溴環十二烷分析流程圖 / Analytical flow chart - HBCDD

測試人員:涂雅苓 / Technician: Yaling Tu

測試負責人:張啟興 / Supervisor: Troy Chang



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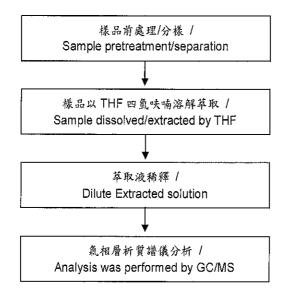
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<u>可塑劑分析流程圖 / Analytical flow chart - Phthalate</u>

測試人員:徐毓明 / Technician: Andy Hsu

測試負責人:張啟興 / Supervisor: Troy Chang

【测試方法/Test method: IEC 62321-8】



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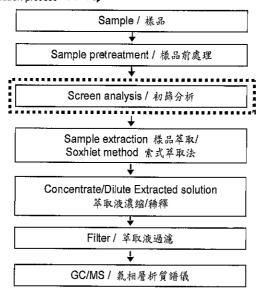
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<u>多溴聯苯/多溴聯苯醚分析流程圖 / Analytical flow chart - PBB/PBDE</u>

■ 測試人員:涂雅苓 / Technician: Yaling Tu

測試負責人:張啟興 / Supervisor: Troy Chang

初次測試程序 / First testing process _ 確認程序 / Confirmation process ■ • ■ • ▶



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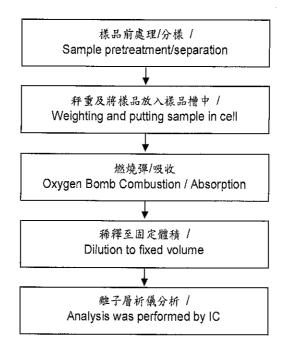
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<u> 鹵素分析流程圖 / Analytical flow chart - Halogen</u>

測試人員:陳恩臻 / Technician: Rita Chen

測試負責人:張啟興 / Supervisor: Troy Chang



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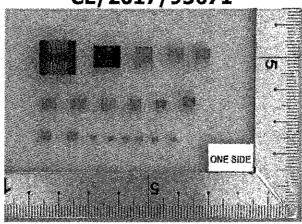
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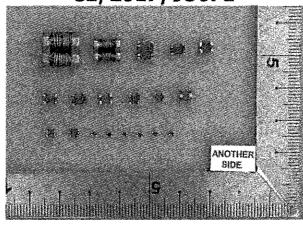
* 照片中如有箭頭標示,則表示為實際檢測之樣品/部位. *

(The tested sample / part is marked by an arrow if it's shown on the photo.)

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